

**BABAK HOSSEINKHALAJ**  
**Professor of Electrical Engineering**  
**Director of Sharif Center for Information Systems and Data Science**  
**Sharif University of Technology**  
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**EDUCATION**

**Ph.D.** in Electrical Engineering, *Stanford University*, Stanford, CA, June 1996.

**M.S.** in Electrical Engineering, *Stanford University*, Stanford, CA, April 1993.

**B.S.** in Electrical Engineering, *Sharif University of Technology*, Tehran, February 1989.

**AREAS OF RESEARCH**

- Next Generation Wireless Networks Analysis and Design (5G and Beyond)
- Cloud-Native SDN-NFV Platform
- Learning, Privacy, and Big Data Analytics for Communication Networks
- Cloud Radio Access Networks (CRAN)

**EXPERIENCE**

*December, 1999 – Now*

*Professor of Electrical Engineering*  
*Sharif University of Technology*

*July, 2018 – September, 2018*

*Nokia Visiting Professor Scholarship*  
*University of Oulu, Oulu, Finland*

*August, 2015 – September, 2015*

*Erasmus-Mundus Visiting Professor*  
*Technical University, Berlin, Germany*

*August, 2007 – September, 2008*

*Fellow of Alexander von Humboldt Foundation*  
*Technical University of Darmstadt, Germany*

*September, 2006 – August, 2007*

*Visiting Professor*  
*Communication Systems and Mathematical Principles of Information Group*  
*CEIT (Centro de Estudios e Investigaciones Tecnicas de Gipuzkoa), San Sebastian, Spain*

*May, 1999 – August, 1999*

*Senior Design Eng. at Ikanos Communications, California*  
Simulation and design of burst-mode xDSL signal estimation and synchronization algorithms  
Design and implementation of optimum multi-input multi-output NEXT/FEXT crosstalk and echo cancellation systems

*November, 1996 – May, 1999*

*Sr. Member of Tech. Staff, Advanced R&D Dept., Advanced Fibre Communications, California*

Design and implementation of broadband VDSL telecommunication systems  
Modeling and simulation of xDSL systems and spectral compatibility studies  
High speed DSP-based clock recovery and convolutional interleaving algorithms  
Fast Reed-Solomon encoding and decoding techniques for DSP-based modems

*June, 1995 - November, 1996*

*Sr. Algorithm Design Engineer at Corporate Technology Dept., KLA Instruments, California*

Signal detection and estimation algorithms for inspection and analysis of difficult wafer layers using advanced imaging techniques; two dimensional defect classification and analysis

*October, 1991 - June 1995*

*Research Assistant at Information Systems Lab., Stanford University, Stanford, California*

*Supervisor: Prof. Thomas Kailath*

*Research Topics:* Antenna arrays technology for CDMA/TDMA cellular networks, multi-channel wireless channel estimation and modeling, modern signal processing techniques for inspection of patterned wafers, blind spatio-temporal channel identification, distortion compensation techniques for accurate overlay and lithography

*June, 1993 - September 1993*

*Member of Tech. Staff at Digital Comm. Research Dept., AT&T Bell Labs, New Jersey*

DSP-implementation of Cellular Digital Packet Data (CDPD) decoding algorithms

Design of high-capacity antenna array-based multi-user TDMA algorithms

## **PATENTS**

1. **US Patent # 11,343,241 B2:** Azad Ravanshid, Alireza Mohammadi, Ali Farahbakhsh, Niusha Moshrefi, Babak Hosein Khalaj, "*Multi-connectivity Communication*", issued May 24, 2022.
2. **US Patent # 10,329,610:** D. Nashtaali, Seyed Abolfazl Motahari, Babak Hossein Khalaj, "*Paired-end sequencing method*", issued June 25, 2019.
3. **US Patent # 10,508,305:** Damoun Nashtaali, Seyed Abolfazl Motahari, Mehrdad Mehrbod, Babak Hossein Khalaj, Mazhareddin Taghivand, "*Sequencing and Processing*", issued December 17, 2019
4. **US Patent # 6,668,041 B2:** J. Kamali, B. H. Khalaj, "*Single Ended Line Probing in DSL System*", issued December 23, 2003
5. **US Patent # 5,513,275:** B. Khalaj, H. Aghajan, and T. Kailath, "*Automated Direct Patterned Wafer Inspection*", issued April 30, 1996

## **HONORS/SOCIETIES**

- IEEE Tutorial Presenter: IEEE PIMRC 2022 and IEEE Globecom 2022
- Co-organizer of IEEE ICC Workshop 2022, Seoul, Korea
- Recipient of 2018 Nokia Visiting Professor Scholarship at University of Oulu
- Recipient of 2015 EU Erasmus-Mundus Visiting Professorship at TU-Berlin
- Recipient of 2007-8 Alexander von Humboldt Fellowship
- Co-editor of Spectral Compatibility Std. for ANSI T1E1.4 Technical Subcommittee, 97-99
- Contributor to ANSI T1E1.4 ADSL Issue II Technical Document, September 1998
- TPC Member of IEEE ICC, Globecom, Infocomm and PIMRC
- Reviewer for IEEE Trans. on Vehicular Technology, IEEE Trans. on Wireless Communications, IEEE Trans. on Communications, and IEEE Trans. on Signal Processing
- Ranked 1st in the National Qualifying Exam for graduate studies abroad, 1990
- Ranked 3rd in the National Undergraduate Exam (out of 200,000 applicants)